R46, Class X2, 310 VAC, 125°C



Overview

The R46 series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V-0.

Applications

For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X2 safety classification. Intended for use in situations in which capacitor failure would not result in exposure to electric shock. Not for use in "series with mains" type applications.

Benefits

Approvals: ENEC, UL, cUL, CQC
X2 CLASS (IEC 60384-14)

Rated voltage: 310 VAC 50/60 Hz
Capacitance range: 0.01 – 15 μF
Lead spacing: 10.0 – 37.5 mm

• Capacitance tolerance: ±20%, ±10%

• Climatic category 40/125/56, IEC 60068-1

Tape & Reel in accordance with IEC 60286-2

· RoHS compliant and lead-free terminations

• Operating temperature range of -40°C to +125°C

• 100% screening factory test at 2,200 VDC/1,500 VAC

© KEMET Electronics Corporation • One East Broward Boulevard Fort Lauderdale, FL 33301 USA • 954-766-2800 • www.kemet.com

Self healing properties



Part Number System

R46	3	N	3220	00	H1	M
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
X2, Metallized Polypropylene	3 = 310	F = 10.0 I = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	H = High Temperature H1 H2 H3 H4 H7	K = ±10% M = ±20%



Ordering Options Table

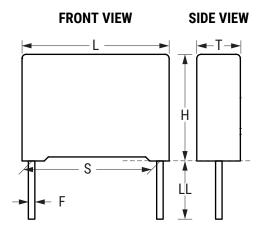
Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4+2/-0	00
	Ammo Pack	H ₀ = 18.5 ±0.5	DQ ¹
	Other Lead and Packaging Options		
	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	CK
10	Tape & Reel (Standard Reel)	H ₀ = 18.5 ±0.5	GY ¹
15	Bulk (Bag)² – Short Leads	2.7 +0.5/-0	JA
22.5	Bulk (Bag)² – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag)² – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag)² – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Bag) - Short Leads	4+2/-0	00 CK ¹
	Tape & Reel (Large Reel) Other Lead and Packaging Options	$H_0 = 18.5 \pm 0.5$	CK.
		0.7.0.5/.0	14
07.5	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
27.5	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray) - Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4+2/-0	00
	Other Lead and Packaging Options		
	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
	Bulk (Tray) - Short Leads	3.5 +0.5/-0	JB
37.5	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50

¹ Not for all sizes, see "Packaging Quantities" table.

² For lead spacing 22.5 case sizes ≥ 8.5*17*26.5 the parts are packed in a Pizza box 335*320*34 mm



Dimensions - Millimeters



	S		Γ		1		L	F	
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
10.0	±0.4	4.0	+0.2/-0.5	9.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
10.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
10.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
15.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	17.5	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.2/-0.5	13.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.2/-0.5	18.5	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	8.5	+0.2/-0.5	14.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	9.0	+0.2/-0.5	12.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	10.0	+0.2/-0.5	16.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	11.0	+0.2/-0.5	19.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	13.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
22.5	±0.4	6.0	+0.2/-0.5	15.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	7.0	+0.2/-0.5	16.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	10.0	+0.2/-0.5	18.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	11.0	+0.2/-0.5	20.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	13.0	+0.2/-0.5	22.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
27.5	±0.4	9.0	+0.2/-0.7	17.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	11.0	+0.2/-0.7	20.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	22.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	25.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	14.0	+0.2/-0.7	28.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	18.0	+0.2/-0.7	33.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	22.0	+0.2/-0.7	37.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
37.5	±0.4	11.0	+0.3/-0.7	22.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	13.0	+0.3/-0.7	24.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	16.0	+0.3/-0.7	28.5	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	19.0	+0.3/-0.7	32.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	20.0	+0.3/-0.7	40.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	24.0	+0.3/-0.7	44.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	30.0	+0.3/-0.7	45.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
		Note: Se	e Ordering O	ptions Tabl	e for lead ler	ngth (LL/H _o)	options.		

© KEMET Electronics Corporation • One East Broward Boulevard Fort Lauderdale, FL 33301 USA • 954-766-2800 • www.kemet.com



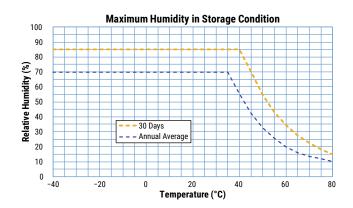
Performance Characteristics

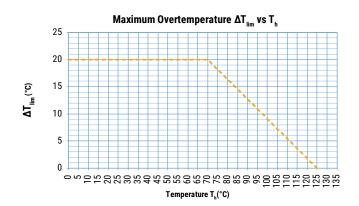
Dielectric	Polypropylene film								
Plates	Metal layer deposited by	Metal layer deposited by evaporation under vacuum							
Winding	Non-inductive type								
Leads	Tinned wire								
Protection	Plastic case, thermosetting	g resin filled. Box material is so	olvent resistant and flame reta	ardant according to UL94.					
Related Documents	IEC 60384-14, EN 60384	-14							
Rated Voltage V _R	310 VAC (50/60 Hz)								
Recommended DC Voltage	≤ 630 VDC								
Capacitance Range	0.010 - 15 μF								
Capacitance Values	E6 series (IEC 60063) me	easured at 1 kHz and +20 ±1°	°C						
Capacitance Tolerance	±10%, ±20%								
Operating Temperature Range	-40°C to +125°C								
Rated Temperature	+125°C								
Climatic Category	40/125/56 IEC 60068-1	40/125/56 IEC 60068-1							
Reliability	Operational life 100,000 l	hours at 85°C; 2,000 hours a	at 125°C						
	Storage time: ≤ 24 months from the date marked on the label package								
	Average relative humidity per year ≤ 70%								
Storage Conditions	RH ≤ 85% for 30 days ran	domly distributed throughou	ut the year						
	Dew is absent								
	Temperature: -40 to 80°0	C (see "Maximum Humidity i	n Storage Conditions" grap	h below)					
Approvals	ENEC, UL, cUL, CQC								
		Maximum Val	lues at +23°C						
Dissipation Factor (tanδ)			C ≤ 0.1 µF	C > 0.1 μF					
	Frequenc	•	0.3%	0.2%					
Test Voltage Between Terminals	The 100% screening factory test is carried out at 2,200 VDC/1,500 VAC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. This test cannot be repeated, as there is a risk of damaging the capacitor. KEMET is not liable in such cases for any failures.								
	Measured at +25°C ±5°C, according to IEC 60384-2								
local de Distri		Minimum Values B	etween Terminals						
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF					
	100 VDC	1 minute	$\geq 1 \cdot 10^5 \mathrm{M}\Omega$ ($\geq 5 \cdot 10^5 \mathrm{M}\Omega$)*	≥ 30,000 MΩ • μF (≥ 150,000 MΩ • μF)*					

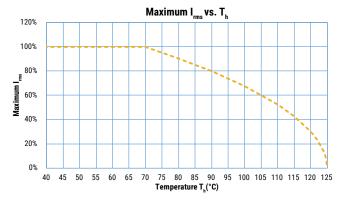
^{*} Typical value



Performance Characteristics cont.

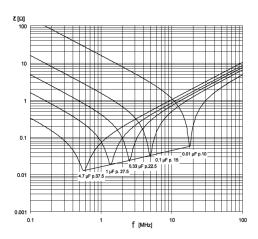






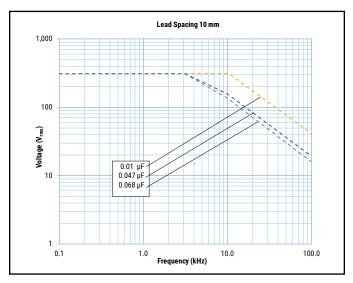
 T_h is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in $^{\circ}$ C.

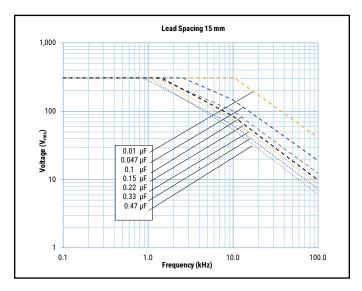
Impedance Graph

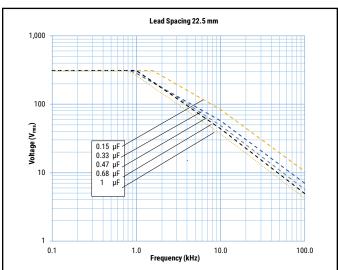


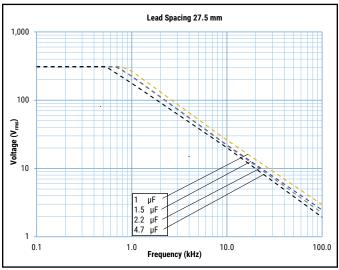


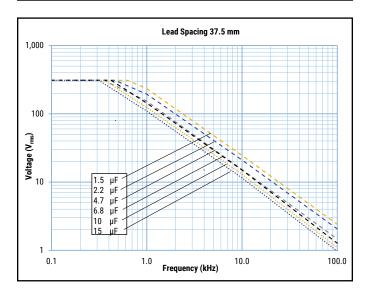
Maximum Voltage (V_{rms}) Versus Frequency (Sinusoidal Waveform/Th $\leq 70^{\circ}$ C)





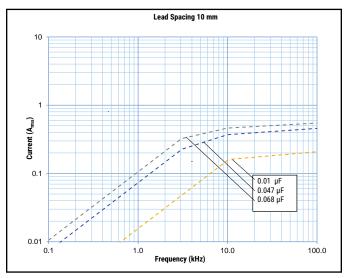


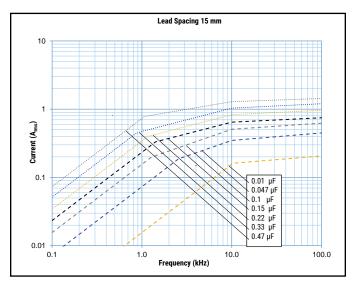


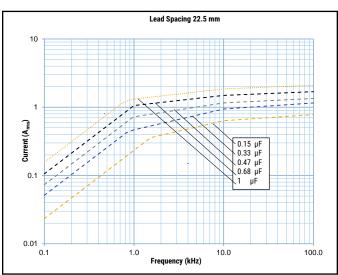


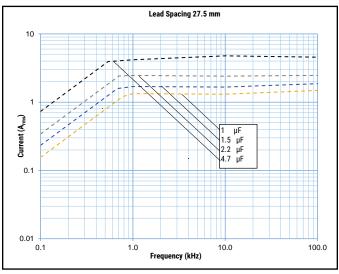


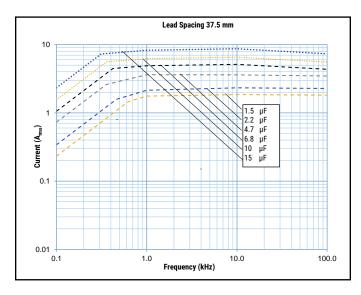
Maximum Current (I_{rms}) Versus Frequency (Sinusoidal Waveform/Th $\leq 70^{\circ}$ C)













Environmental Test Data

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384-14	$1.25 \text{x} \text{V}_{\text{R}} \text{VAC} 50 \text{Hz}$, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s²
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s ²
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V _R + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days

Approvals

Certification Body	Mark	Specification	File Number
IMQ S-p.A.		EN/IEC 60384-14	CA08.00063
UL	c SN °us	UL 60384-14 and CAN/CSA E60384-14 (310 VAC)	E97797
CQC	cec	IEC 60384-14	CQC15001128630 CQC15001128703 CQC15001128705

Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.





Table 1 - Ratings & Part Number Reference

Capacitance	Dime	ensions ir	n mm	Lead Spacing	dV/dt	KEMET	Legacy Part
Value (µF)	Т	Н	L	(S)	(V/µs)	Part Number	Number
0.01	4.0	9.0	13.0	10.0	500	463F2100(1)H7(2)	R463F2100(1)H7(2)
0.01	5.0	11.0	13.0	10.0	500	463F2100(1)H1(2)	R463F2100(1)H1(2)
0.015	4.0	9.0	13.0	10.0	500	463F2150(1)H7(2)	R463F2150(1)H7(2)
0.015	5.0	11.0	13.0	10.0	500	463F2150(1)H1(2)	R463F2150(1)H1(2)
0.022	4.0	9.0	13.0	10.0	500	463F2220(1)H7(2)	R463F2220(1)H7(2)
0.022	5.0	11.0	13.0	10.0	500	463F2220(1)H1(2)	R463F2220(1)H1(2)
0.033	5.0	11.0	13.0	10.0	500	463F2330(1)H1(2)	R463F2330(1)H1(2)
0.047	5.0	11.0	13.0	10.0	500	463F2470(1)H7(2)	R463F2470(1)H7(2)
0.047	6.0	12.0	13.0	10.0	500	463F2470(1)H1(2)	R463F2470(1)H1(2)
0.068	6.0	12.0	13.0	10.0	500	463F2680(1)H1(3)	R463F2680(1)H1(3)
0.010	5.0	11.0	18.0	15.0	400	463I2100(1)H1(2)	R463I2100(1)H1(2)
0.015	5.0	11.0	18.0	15.0	400	463I2150(1)H1(2)	R463I2150(1)H1(2)
0.022	5.0	11.0	18.0	15.0	400	463I2220(1)H1(2)	R463I2220(1)H1(2)
0.033	5.0	11.0	18.0	15.0	400	463I2330(1)H1(2)	R463I2330(1)H1(2)
0.047	5.0	11.0	18.0	15.0	400	463I2470(1)H1(2)	R463I2470(1)H1(2)
0.068	5.0	11.0	18.0	15.0	400	463I2680(1)H1(2)	R463I2680(1)H1(2)
0.10	5.0	11.0	18.0	15.0	400	463I3100(1)H7(2)	R463I3100(1)H7(2)
0.10	6.0	12.0	18.0	15.0	400	463I3100(1)H1(2)	R463I3100(1)H1(2)
0.15	6.0	12.0	18.0	15.0	400	463I3150(1)H7(2)	R463I3150(1)H7(2)
0.15	6.0	17.5	18.0	15.0	400	463I3150(1)H2(2)	R463I3150(1)H2(2)
0.15	9.0	12.5	18.0	15.0	400	463I3150(1)H3(2)	R463I3150(1)H3(2)
0.15	7.5	13.5	18.0	15.0	400	463I3150(1)H1(2)	R463I3150(1)H1(2)
0.22	7.5	13.5	18.0	15.0	400	463I3220(1)H7(2)	R463I3220(1)H7(2)
0.22	8.5	14.5	18.0	15.0	400	463I3220(1)H1(2)	R463I3220(1)H1(2)
0.22	6.0	17.5	18.0	15.0	400	463I3220(1)H2(3)	R463I3220(1)H2(3)
0.22	9.0	12.5	18.0	15.0	400	463I3220(1)H3(3)	R463I3220(1)H3(3)
0.22	7.5	18.5	18.0	15.0	400	463I3220(1)H4(2)	R463I3220(1)H4(2)
0.33	8.5	14.5	18.0	15.0	400	463I3330(1)H7(2)	R463I3330(1)H7(2)
0.33	10.0	16.0	18.0	15.0	400	463l3330(1)H1(3)	R463I3330(1)H1(3)
0.33	7.5	18.5	18.0	15.0 15.0	400	463I3330(1)H2(3)	R463I3330(1)H2(3)
0.33 0.47	13.0 10.0	12.0 16.0	18.0 18.0	15.0	400 400	463l3330(1)H3(3)	R463I3330(1)H3(3)
0.47	11.0	19.0	18.0	15.0	400	463I3470(1)H7(3) 463I3470(1)H1(3)	R463I3470(1)H7(3) R463I3470(1)H1(3)
0.68	11.0	19.0	18.0	15.0	400	463I3680(1)H7(3)	R463I3680(1)H7(3)
0.15	6.0	15.0	26.5	22.5	200	463N3150(1)H1(2)	R463N3150(1)H1(2)
0.22	6.0	15.0	26.5	22.5	200	463N3220(1)H1(2)	R463N3220(1)H1(2)
0.33	6.0	15.0	26.5	22.5	200	463N3330(1)H7(2)	R463N3330(1)H7(2)
0.33	7.0	16.0	26.5	22.5	200	463N3330(1)H1(2)	R463N3330(1)H1(2)
0.47	7.0	16.0	26.5	22.5	200	463N3470(1)H7(2)	R463N3470(1)H7(2)
0.47	10.0	18.5	26.5	22.5	200	463N3470(1)H1(2)	R463N3470(1)H1(2)
0.68	10.0	18.5	26.5	22.5	200	463N3680(1)H7(2)	R463N3680(1)H7(2)
0.68	11.0	20.0	26.5	22.5	200	463N3680(1)H1(2)	R463N3680(1)H1(2)
1.0	11.0	20.0	26.5	22.5	200	463N4100(1)H7(2)	R463N4100(1)H7(2)
1.0	13.0	22.0	26.5	22.5	200	463N4100(1)H1(2)	R463N4100(1)H1(2)
1.5	13.0	22.0	26.5	22.5	200	463N4150(1)H7(2)	R463N4150(1)H7(2)
1	11.0	20.0	32.0	27.5	150	463R4100(1)H7(2)	R463R4100(1)H7(2)
1.5	13.0	22.0	32.0	27.5	150	463R4150(1)H7(2)	R463R4150(1)H7(2)
2.2	14.0	28.0	32.0	27.5	150	463R4220(1)H7(2)	R463R4220(1)H7(2)
3.3	18.0	33.0	32.0	27.5	150	463R4330(1)H7(2)	R463R4330(1)H7(2)
4.7	22.0	37.0	32.0	27.5	150	463R4470(1)H7(2)	R463R4470(1)H7(2)
1.5	11.0	22.0	41.5	37.5	100	463W4150(1)H7(2)	R463W4150(1)H7(2)
2.2	13.0	24.0	41.5	37.5	100	463W4220(1)H7(2)	R463W4220(1)H7(2)
3.3	16.0	28.5	41.5	37.5	100	463W4330(1)H7(2)	R463W4330(1)H7(2)
4.7	19.0	32.0	41.5	37.5	100	463W4470(1)H7(2)	R463W4470(1)H7(2)
6.8	20.0	40.0	41.5	37.5	100	463W4680(1)H7(2)	R463W4680(1)H7(2)
10	24.0	44.0	41.5	37.5	100	463W5100(1)H7(2)	R463W5100(1)H7(2)
15	30.0	45.0	41.5	37.5	100	463W5150(1)H7(3)	R463W5150(1)H7(3)
	_,		.,	Lead	D. 21 - 22 - 3	KEMET	Legacy
Capacitance Value (µF)	T (mm)	H (mm)	L (mm)	Spacing (S)	dV/dt (V/μs)	Part Number	Part Number
	l		l	pauling (0)		1	

⁽¹⁾ Insert lead and packaging code. See Ordering Options Table for available options.

⁽²⁾ $M = \pm 20\%$, $K = \pm 10\%$

⁽³⁾ $M = \pm 20\%$ (only available tolerance).



Soldering Process

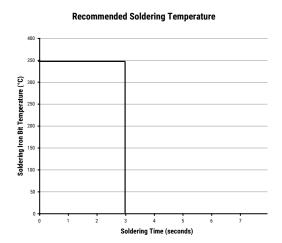
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder material. This has increased the liquidus temperature from 183° C for SnPb eutectic alloys to $217 - 221^{\circ}$ C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher preheat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm). Great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above-recommended limits may result to degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal temperature before performing the second soldering cycle.

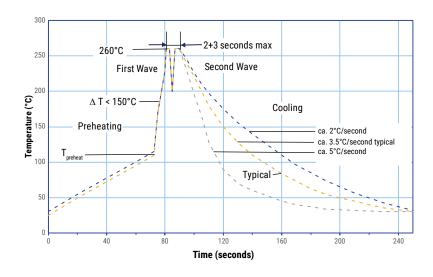
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

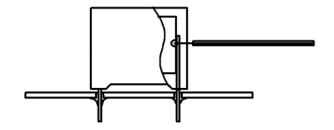
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric Film Material	Pre	mum heat erature	Maximum Peak Soldering Temperature			
	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm		
Polyester	130°C	130°C	270°C	270°C		
Polypropylene	125°C	130°C	260°C	270°C		
Paper	130°C	140°C	270°C	270°C		
Polyphenylene Sulphide	150°C	160°C	270°C	270°C		

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature inside the element is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	125°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

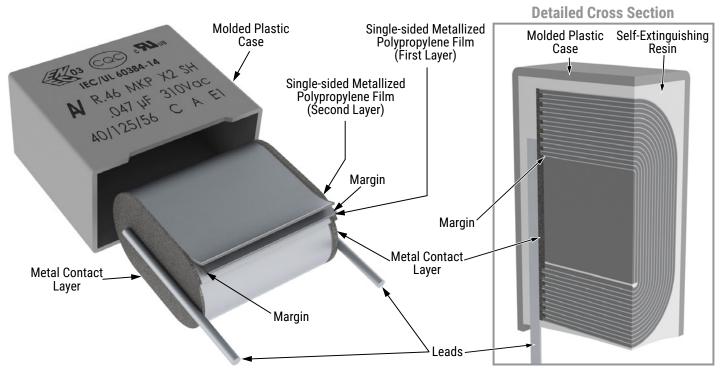
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as it is in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

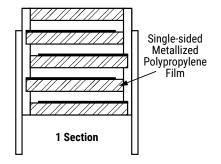
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 – 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.



Construction



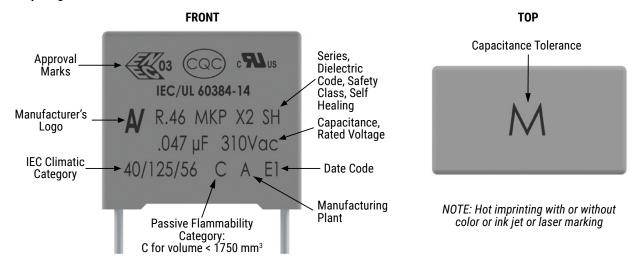
Winding Scheme



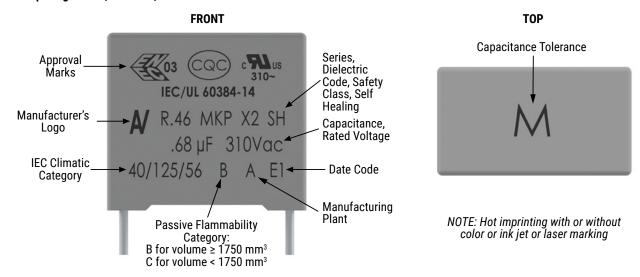


Marking

Lead Spacing 10 mm



Lead Spacing 15 mm, 22.5 mm, and 27.5 mm



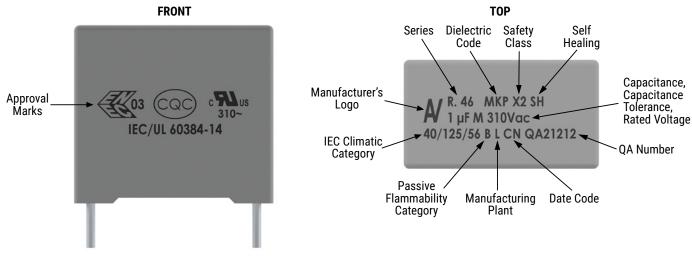
Slight change in the layout can be possible but this does not affect the content of the information of the current marking.

This change will be achieved without impact to product form, fit or function, as the products are equivalent with respect to physical, mechanical, quality and reliability characteristics.



Marking cont.

Lead Spacing 22.5 and 27.5 mm (alternatives*) and 37.5 mm



*Differences are caused by technology (clichee, laser, or ink) and production line.

Slight change in the layout can be possible but this does not affect the content of the information of the current marking.

This change will be achieved without impact to product form, fit or function, as the products are equivalent with respect to physical, mechanical, quality and reliability characteristics.

	Manufacturing Date Code (IEC 60062)												
Year Code Year Code Month Code Month C													
2020	М	2027	V	2034	Е	January	1	July	7				
2021	N	2028	W	2035	F	February	2	August	8				
2022	Р	2029	X	2036	Н	March	3	September	9				
2023	R	2030	Α	2037	J	April	4	October	0				
2024	S	2031	В	2038	K	May	5	November	N				
2025	Т	2032	С	2039	L	June	6	December	D				
2026	U	2033	D	2040	М								



Packaging Quantities

Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads		ulk Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped
Lead and Packaging Code:			00 - JA - JB JE - JH	JM	40 - 50	GY	СК	DQ	
	4	9	13	2,000	2,200	1,800	750	1,500	1,000
10	5	11	13	1,300	2,000	1,500	600	1,250	800
	6	12	13	1,000	1,800	1,200	500	1,000	680
	F	11	10	2.000	1.050	1 000	600	1.050	000
	5	11	18	2,000	1,250	1,000	600	1,250	800
	6	12	18	1,750	1,000	900	500	1,000	680
	6	17.5	18	1,000	800	700	500	1,000	680
	7.5	13.5	18	1,000	800	700	350	800	500
15	7.5	18.5	18	900	650	500	-	800	500
	8.5	14.5	18	1,000	650	500	300	700	440
	9	12.5	18	1,000	700	520	270	650	410
	10	16	18	750	550	500	270	600	380
	11	19	18	450	400	350	-	500	340
	13	12	18	750	520	490	200	480	280
	6	15	26.5	805	450	500	-	700	464
	7	16	26.5	700	450	500	-	550	380
22.5	10	18.5	26.5	396	350	300	-	350	235
	11	20	26.5	360	200	250	-	350	217
	13	22	26.5	300	150	200	-	300	
		47	00	016	400	400		450	
	9	17	32	816	408	408	-	450	-
	11	20	32	560	336	336	-	350	-
27.5	13	22	32	480	288	288	-	300	-
	14	28	32	352	176	176	-	-	-
	18	33	32	256	128	128	-	-	-
	22	37	32	168	112	112	-	-	-
	11	22	41.5	420	252	252	-	-	-
	13	24	41.5	360	216	216	-	-	-
	16	28.5	41.5	216	108	108	-	-	-
37.5	19	32	41.5	192	96	96	-	-	-
	20	40	41.5	126	84	84	-	-	-
	24	44	41.5	108	72	72	-	-	-
	30	45	41.5	90	60	60	-	-	-

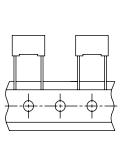


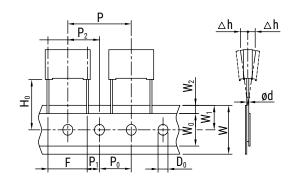
Lead Taping & Packaging (IEC 60286-2)

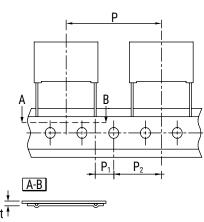
Figure 1 Lead Spacing 10 mm

Figure 2 Lead Spacing 15 mm

Figure 3 Lead Spacing 22.5 – 27.5 mm







Taping Specification

			Dim	ensions (r	nm)	
Description	Symbol					
Description	Cymbol	10	15	22.5	27.5	Tol.
		Fig. 1	Fig. 2	Fig. 3	Fig. 3	
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05
Taping lead space	Р	25.4	25.4	38.1	38.1	±1
Feed hole lead space *	P_0	12.7	12.7	12.7	12.7	±0.2 **
Centering of the lead wire	P_1	7.7	5.2	7.8	5.3	±0.7
Centering of the body	P_{2}	12.7	12.7	19.05	19.05	±1.3
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1
Component alignment	Δh	0	0	0	0	±2
Height of component from tape center	H ₀ ****	18.5	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	18	+1/-0.5
Hold down tape width	W_{0}	9	10	10	10	Minimum
Hole position	W_1	9	9	9	9	±0.5
Hold down tape position	W_2	3	3	3	3	Maximum
Feed hole diameter	D _o	4	4	4	4	±0.2
Total tape thickness	t	0.7	0.7	0.7	0.7	±0.2

^{* 15} mm also available

^{**} Maximum of 1 mm on 20 lead spaces

^{***} Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

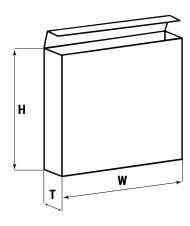
^{****} H_0 = 16.5 mm is available upon request



Lead Taping & Packaging (IEC 60286-2) cont.

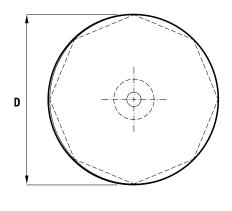
Ammo Specifications

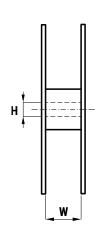
Dimensions (mm)				
Н	W	Т		
360	340	59		



Reel Specifications

Reel Size	Dimensions (mm)		
Reel Size	D	Н	W
Standard	355	30	55 Maximum
Large	500	25	







KEMET Electronics Corporation Sales Offices

For a complete list of our global sales offices, please visit www.kemet.com/sales.

Disclaimer

YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

Additional information about production site flexibility can be found <here>